

SST-10-B

Blue LED

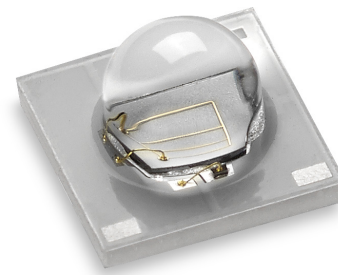
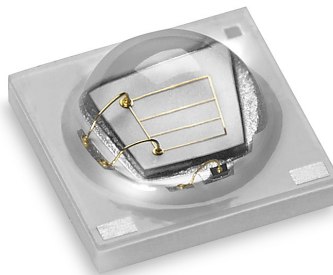


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Features:

- High Power Blue LED with Peak Wavelength of 450nm
- Wall-Plug Efficiency: typ. 57% @350mA
- 90 or 130° viewing angle at 50% Iv
- Low Thermal Resistance
- Built-in ESD Protection
- RoHS and REACH compliant

Applications

- | | |
|------------------------------|----------------------------|
| • Horticulture / Growlights | • Remote-phosphor fixtures |
| • Accent and effect lighting | • Stage lighting |
| • Architectural lighting | |

SST-10 Binning Structure

SST-10 Blue LEDs are tested for luminous flux and chromaticity at a drive current of 350mA - 20ms single pulse and placed into one of the following luminous flux (FF) and chromaticity (WW) bins:

Flux Bins - Test condition=350mA, 25°C, 20ms pulse

Flux Bin (FF)	Minimum Flux (mW)	Maximum Flux (mW)
N	510	550
P	550	590
Q	590	630
R	630	670

Wavelength Bins - Test condition=350mA, 25°C, 20ms pulse

Chromaticity Bin (WW)	Minimum Wavelength (nm)	Maximum Wavelength (nm)
B2	440	445
B3	445	450
B4	450	455
B5	455	460

*Note: Luminus maintains a +/- 6% tolerance on flux measurements.

Ordering Information

Products	Ordering Part Number	Description
SST-10-B-B90	SST-10-B-B90-xx123	High Power 1-mm ² Blue LED in a 3535 surface mount package and a 90-degree lens
SST-10-B-B130	SST-10-B-B130-xx123	High Power 1-mm ² Blue LED in a 3535 surface mount package and a 130-degree lens

Part Number Nomenclature

SST — 10 — <A> — <B###> — <FF###>

Product Family	LED Emission Area	Color	Package Configuration	Bin kit
SST: Surface Mount Package	10: 1.0 mm ²	<A>: Color B = Blue	B90: 90-degree lens B130: 130-degree lens	Flux and Chromaticity bin kit code - See available ordering codes below

SST-10 Bin Kit Order Codes

The following table describes the bin kit ordering codes available for the SST-10 Blue LEDs. Each bin kit specifies a minimum flux as well as specific chromaticity bins allowed. Please note that within each kit a maximum flux is not specified and as a result Luminus may ship any part meeting or exceeding the minimum flux specification. Shipments will always meet the listed chromaticity bins. For information on ordering bin kits not listed below, please contact Luminus.

SST-10 Blue Bin Kit Order Codes

Color	Luminous Flux		Chromaticity Bins	Kit Number
	Bin Kit Flux Code	Min. Flux		
Blue	N	510	B2,B3,B4,B5	N450

Product Shipping & Labeling Information

All SST-10 products are packaged and labeled with their respective bin as outlined in the tables on pages 2 & 3. Each reel will only contain one bin.

SST-10 Blue

SST — 10 — B — BXXX — FFWW

Product Family	LED Emission Area	Color	Package Configuration	Bin kit
SST: Surface Mount Package	10: 1.0 mm ²	Color	B90: 90-degree lens B130: 130-degree lens	Flux and Chromaticity bin kit code as outlined above

Optical and Electrical Characteristics

Optical and Electrical Characteristics at 350mA¹

Parameter	Symbol	Minimum	Typical	Maximum	Unit
Forward Current ²	I_f		350	1,500	mA
Output Power	Φ_r		600		mW
Forward Voltage	V_f	2.7	3.0	3.4	V
Wall-Plug Efficiency	WPE		57		%
Viewing Angle	$2\ \varnothing_{1/2}$		90 or 130		degrees
Peak Wavelength	λ_p	440	450	460	nm
FWHM	$\Delta\lambda_{1/2}$	20	22	24	nm
Thermal Resistance (Electrical)	R_{TH}		5.3		°C/W

Absolute Maximum Ratings²

Parameter	Symbol	Rating	Unit
Forward Current ^{3,4}	I	1.5	A
Power Dissipation	P_D	5.0	W
Reverse Voltage	V_R	5	V
Storage Temperature	T_{STG}	-40~100	°C
Junction Temperature ^{3,4}	T_J	115 °C	°C
Soldering Temperature	T_{SLD}	JEDEC 020, 260 °C	
ESD Sensitivity (HBM)	V_B	6000	V

Note 1: Ratings are based on operation at a constant junction temperature of $T_j = 25^\circ\text{C}$.

Note 2: To prevent damage, please refer to operating conditions and derating curves for appropriate maximum operating conditions

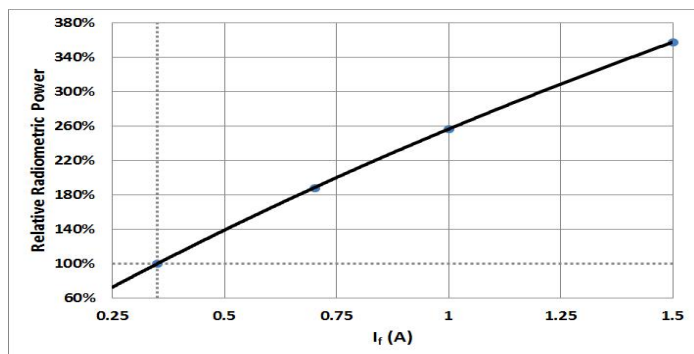
Note 3: Maximum operating case temperature combined with maximum drive current defines the total maximum operating condition for the device. To prevent damage, please follow derating curves for all operating conditions.

Note 4: Luminus SST-10-Blue LEDs are designed for operation up to an absolute maximum forward drive current as specified above. Product lifetime data is specified at typical forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to typical forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to the current vs. junction temperature derating curves for further information. In pulsed operation, rise time from 10-90% of forward current should be larger than 0.5 microseconds.

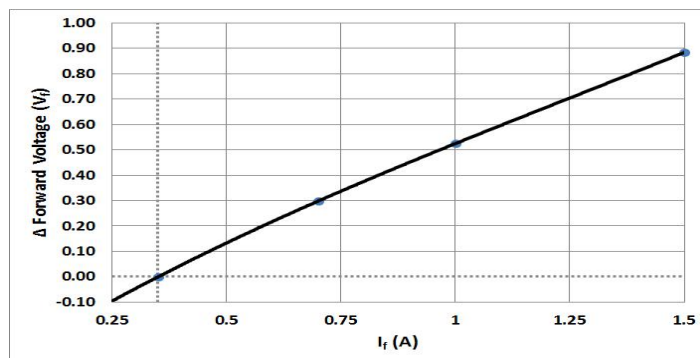
Note 5: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.

Optical and Electrical Characteristics

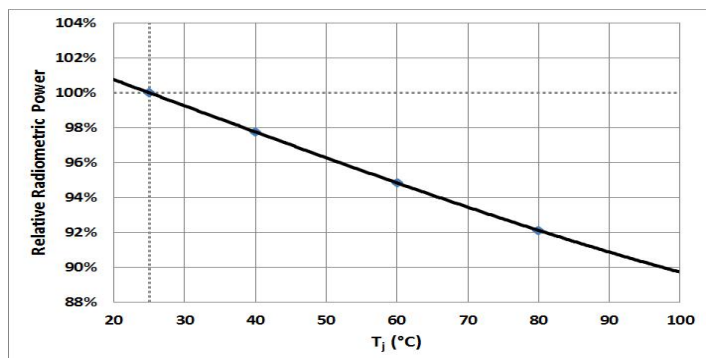
Relative Output Flux vs. Forward Current



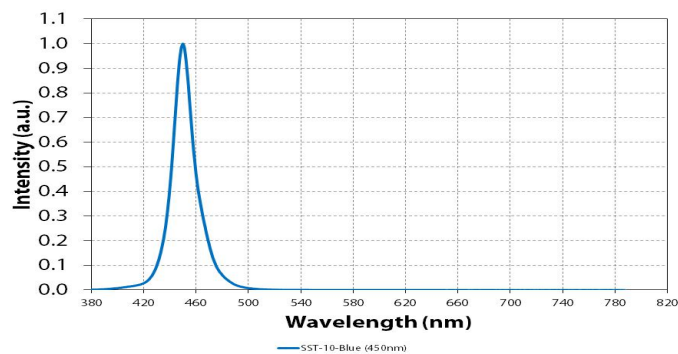
Forward Current vs. Forward Voltage



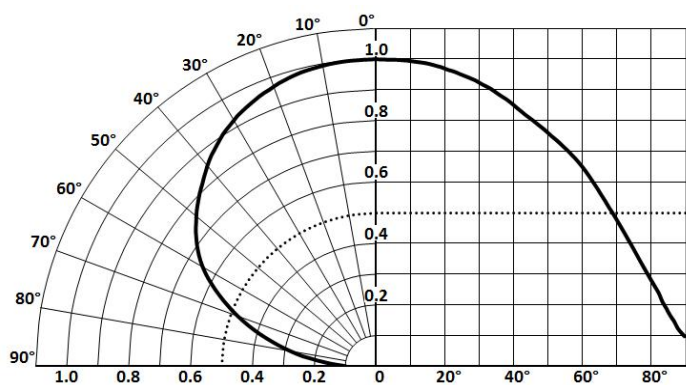
Relative Output Flux vs. Junction Temperature



Typical Spectra



Typical Polar Radiation Plot - B130



Typical Polar Radiation Plot - B90

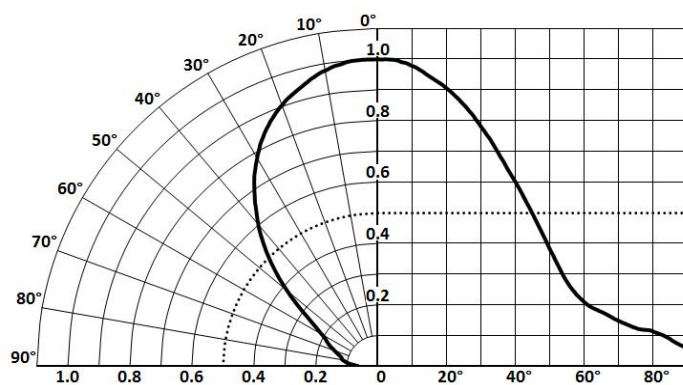


Figure 1: Dimensions and Recommended Solder Pad Layout for the 1000 Series LED

Top View Dimensions:

- Overall width: $2.23 \pm .088$
- Overall height: $3.45 \pm .20 \pm .008 \pm .136 \pm .000$
- Die emitting area width: $1.1 \pm .044$
- Die emitting area height: $1.1 \pm .044$
- Center of die emitting area: $\phi .15 \pm .006 \text{ (M) A B}$
- Center of Zener diode: $\phi .30 \pm .012 \text{ (M) A B}$
- Dimensions from top edge: $1.38 \pm .054$, $1.18 \pm .046$
- Dimensions from left edge: $1.38 \pm .054$, $1.18 \pm .046$
- Dimension from bottom edge: $1.1 \pm .044$

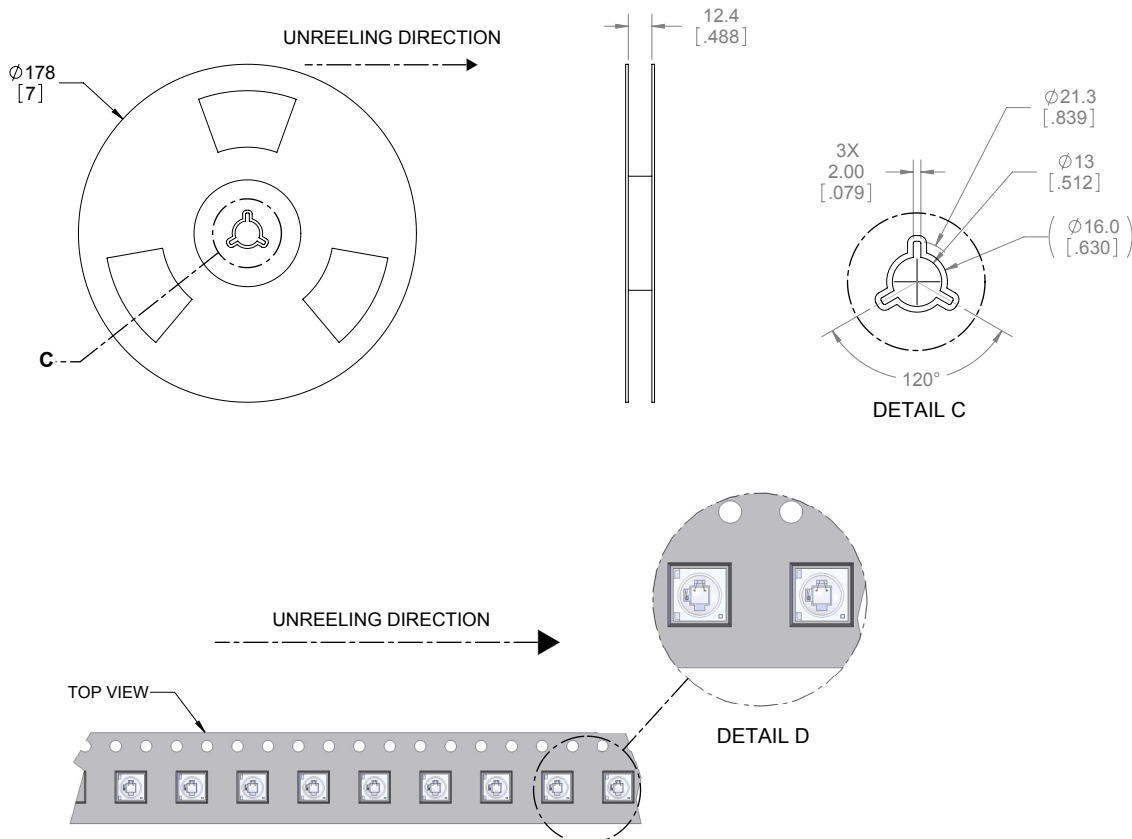
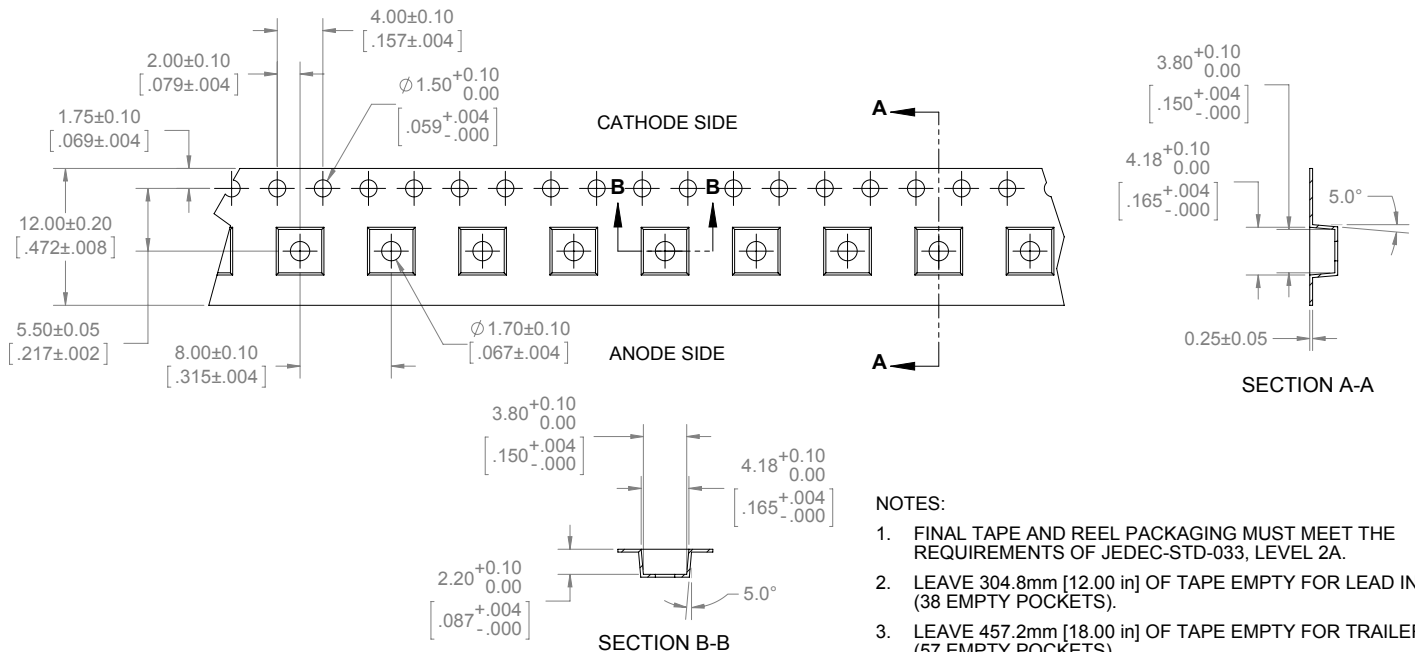
Section E-E Dimensions:

- Die diameter: $\phi 2.60 \pm .102$
- Substrate thickness: $1.90 \pm .13 \pm .075 \pm .005$
- Die thickness: $.62 \pm .13 \pm .024 \pm .005$
- Back of substrate to top of die emitting area: $.62 \pm .13 \pm .024 \pm .005$
- Radius: $R.2 \pm .006$

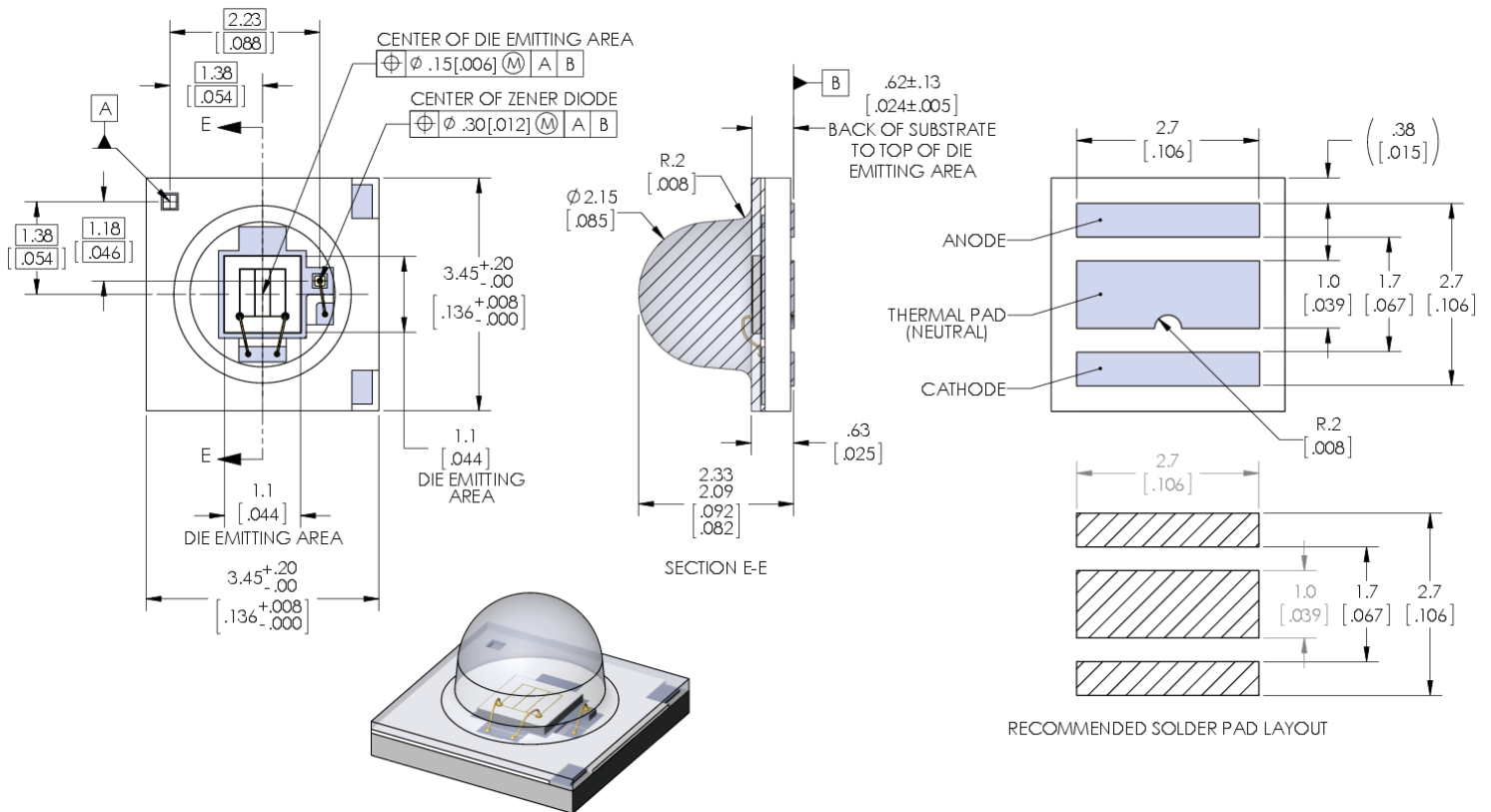
Recommended Solder Pad Layout Dimensions:

- Overall width: $2.7 \pm .106$
- Overall height: $2.7 \pm .106$
- Anode width: $1.0 \pm .039$
- Thermal pad (neutral) width: $1.7 \pm .067$
- Cathode width: $1.0 \pm .039$
- Radius: $R.2 \pm .008$

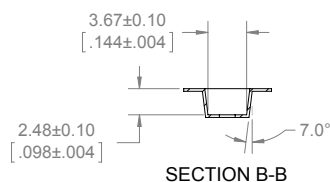
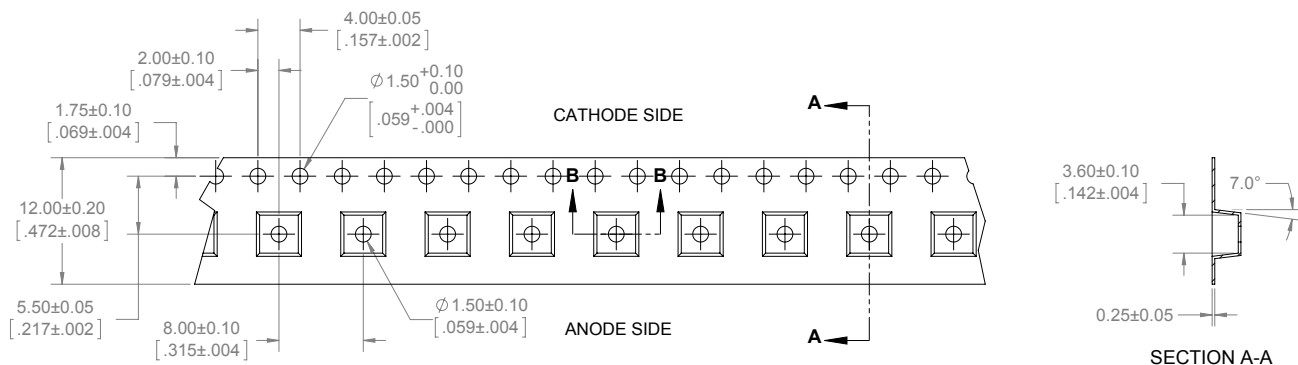
Tape and Reel - B130 Package



Mechanical Dimensions - B90 Package

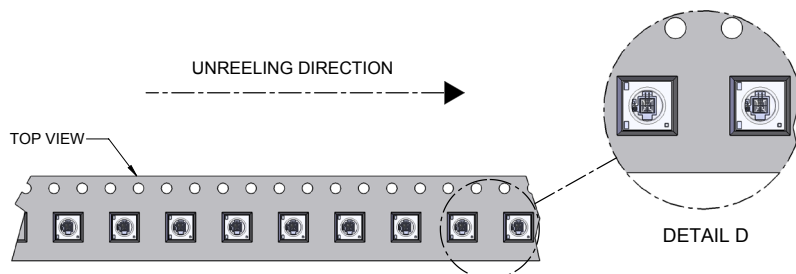
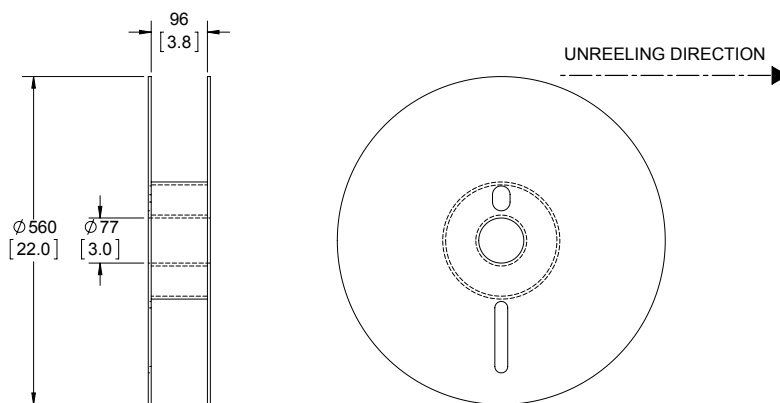


Tape and Reel - B90 Package



NOTES:

1. FINAL TAPE AND REEL PACKAGING MUST MEET THE REQUIREMENTS OF JEDEC-STD-033, LEVEL 2A.
2. LEAVE 304.8mm [12.00 in] OF TAPE EMPTY FOR LEAD IN (38 EMPTY POCKETS).
3. LEAVE 457.2mm [18.00 in] OF TAPE EMPTY FOR TRAILER (57 EMPTY POCKETS).
4. MUST COMPLY TO EIA-481-C-2003

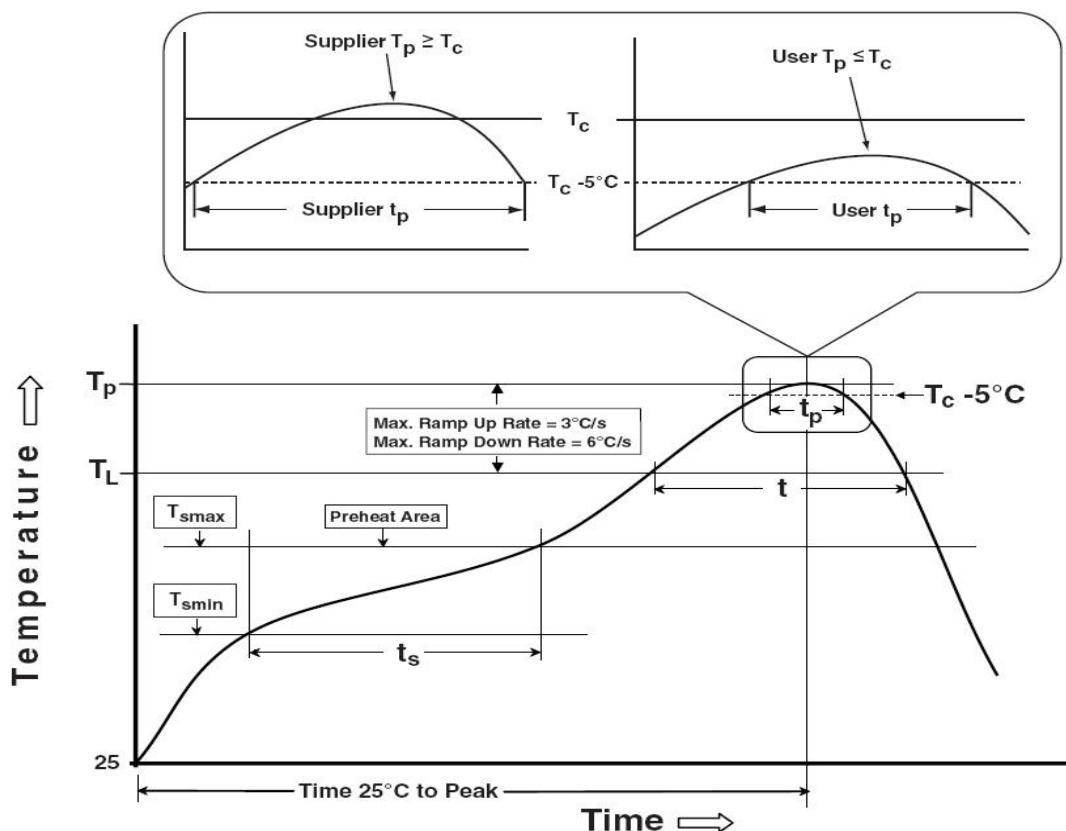


Soldering Profile

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak	100 °C	150 °C
Temperature min (T _{smin})	150 °C	200 °C
Temperature max (T _{smax})	60-120 seconds	60-120 seconds
Time (T _{smin} to T _{smax}) (t _s)		
Average ramp-up rate (T _{smax} to T _p)	3 °C/second max	3 °C/second max
Liquidous temperature (T _L)	183 °C	217 °C
Time at liquidous (t _L)	60-150 seconds	60-150 seconds
Peak package body temperature (T _p)*	230 °C ~235 °C	255 °C ~260 °C
Classification temperature (T _c)	235 °C	260 °C
Time (t _p) within 5 °C of the specified classification temperature (T _c)	20 seconds	30 seconds
Average ramp-down rate (T _p to T _{smax})	6 °C/second max	6 °C/second max
Time 25 °C to peak temperature	6 minutes max	8 minutes max

* Tolerance for peak profile temperature(T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature(t_p) is defined as a supplier minimum and a user maximum.



Precautions for Use

Storage:

1. Before opening the package

The LEDs should be kept at a temperature lower than 40° C and relative humidity lower than 90%. The LEDs should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

2. After opening the package

The LEDs should be kept at temperature lower than 30° C and relative humidity lower than 60%. The LEDs should be soldered within 168 hours (7days) after opening the moisture proof package.

If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with moisture proof package within absorbent material (silica gel). It is also recommended to return the unused LEDs to the original moisture proof package and to seal the moisture proof package again.

If the moisture absorbent material (silica gel) vapors or expires the expiration date, baking treatment should be performed by using the following conditions : 60 °C for 20 hours.

The LEDs electrode and leadframe comprise a silver plated copper alloy. The silver surface may be affected by environments. Please avoid conditions which may cause the LEDs to corrode or discolore. The corrosion or discoloration might lower solderability or affect optical characteristics.

Please avoid rapid transition in ambient temperature, especially in high humidity environments where condensation can occur.

Static Electricity:

1. The products are sensitive to static electricity, and care should be taken when handling them.

2. Static electricity or surge voltage will damage the LEDs. It is recommended to wear a anti-electrostatic wristband or anti-electrostatic gloves when handling the LEDs.

3. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.

History of Changes

Rev		Description of Change
01	09/14/2015	Initial Release - Preliminary Specifications
02	10/13/2015	Updated solder pad layout and added 80-degree lens option
03	04/15/2016	Updated binning and angular distribution data. Added 90-degree tape & reel
04	06/24/2016	Updated pictures on front page
05	04/03/2017	Updated title in "Relative Output Flux vs. Junction Temperature" graph and address.